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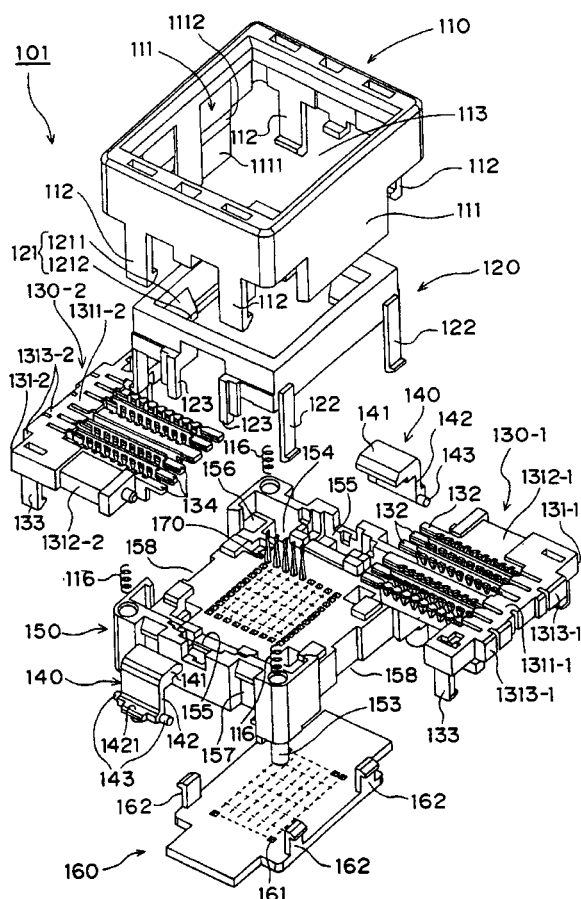
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(54) Title: SEMICONDUCTOR COMPONENT TEST SOCKET



(57) Abstract: A semiconductor component test socket may be used to connect semiconductor components to a semiconductor component testing apparatus. The test socket is small, light in weight, and has a lower manufacturing cost than conventional test sockets. The test socket includes an interposing assembly and a frame body that includes a biasing member for moving interposed first and second interposing members, of the interposing assembly, from a standby position to a compact position for releasably connecting a semiconductor component to the semiconductor component test socket.

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